



MIRO 3-3I610CW (3 Layer)

Fanless Embedded Computer with 6th/7th Gen Intel® Skylake-U / Kaby Lake-U i7 / i5 / i3 processor

■ Features:

- 6th / 7th Gen Intel® Skylake-U / Kaby Lake-U i7 / i5 / i3 processor
- DDR4 SODIMM socket, Max. 32GB
- 2 x GbE, 6 x COM, VGA, DVI, 4 x USB
- Wide Range 9~36V DC input
- DIN Rail mountable (with optional Kit)

■ Specifications :

Motherboard	3I610CW
CPU	Intel® Skylake-U / Kaby Lake-U i7 / i5 / i3 CPU
Chipset	Intel Skylake-U / Kaby Lake-U SoC
Memory	1 x DDR4 SODIMM socket, Max. 32GB
Storage	mSATA, HDD / SSD*
Expansion slots	1 x Full-size Mini PCIe (USB / mSATA) 1 x Full-size Mini PCIe (PCIe / USB 2.0)
I/O ports	Network 2 x Intel GbE USB 4 x USB 3.0 Serial ports 6 x COM Display VGA, DVI GPIO DI / DO (optional)
Optional Modules & Accessory	GPS, Bluetooth, WiFi, 4G LTE, DI/O, Isolated COM *VESA Mount Kit, *DIN Rail Mounting Kit *Wall Mount Kit, *SATA Kit *External Power Adapter
OS Support	7th Generation Intel® Core™ Processor family: Kaby Lake Windows® 10 IOT (64bit), Ubuntu 16.04.3 above, Fedora 26 above, CentOS 7.4 above 6th Generation Intel® Core™ Processor family: Skylake Windows® 10 IOT (64bit) Windows® 8.1 (64bit) Windows® Embedded 8 Standard (64bit) Windows® 7 (64bit) Windows® Embedded Sta 7 (64bit) Ubuntu 16.04.3 above, Fedora 26 above, CentOS 7.4 above

■ Mechanical

Dimensions	178W x 116D x 90.9H mm
Weight	1.75 kg
Mounting	Wall Mount*, DIN Rail Mount*, VESA Mount*

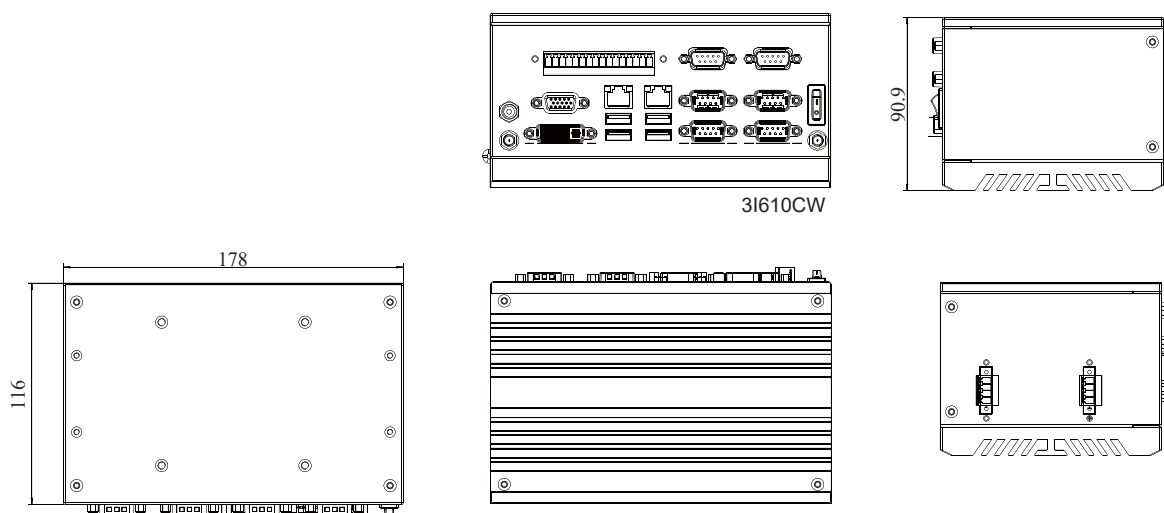
■ Power

DC input	+9~36V
AC input	External adapter 100 / 240V

■ Environment

Operating Temp. (100 % CPU usage)	-20°C to +60°C (Celeron 3955U) -20°C to +50°C (Core i5 6300U) -20°C to +50°C (Core i7 6600U) -20°C to +50°C (Core i3 6100U) *W / Industrial SSD
Storage Temp.	-20°C to +70°C
Relative Humidity	95% @ 40°C, non-condensing
Certification	CE / FCC, IEC / IECCE

■ Dimension



Specification are subject to change without prior notice. ODM / OEM is available.